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Structure	Silicon Monolithic Integrated Circuit
Product Series	4ch Sensorless System Motor Driver for MD
Type	BD6640KVT

Features

- Operates at low power supply voltage (2.1V min)
- Power DMOS output with low ON resistance (0.8Ω Typ.)
- Incorporates a charge pump circuit for VG boost.
- 3-phase full-wave soft-switching sensorless driver for spindle
- 3-value control 3-phase driver for sled (built-in comparator for BEMF voltage detection)
- 2ch, 3-value control H-bridges for focus/tracking
- PWM half-bridge for spindle VM power supply

○Absolute maximum ratings(Ta=25℃)

Parameter	Symbol	Limit	Unit
Power supply voltage for control circuit	VCC	7	V
Power supply voltage for driver block	VM	7	V
Power supply voltage for pre-driver block	VG	14	V
Input voltage	VIN	0～VCC	V
Output current	Iomax	*500	mA
Power dissipation	Pd	**1250	mW
Operating temperature range	Topr	-25～+75	℃
Storage temperature range	Tstg	-55～+150	℃
Junction temperature	Tjmax	+150	℃

＊Must not exceed Pd or ASO, Tjmax=150℃.

＊＊Reduced by 10mW/°C over Ta=25°C, when mounted on a glass epoxy board (70mm×70 mm×1.6mm).

○Operating conditions (Ta=-25～+75°C)

Parameter	Symbol	Min.	Typ.	Max	Unit
Power supply voltage	VCC1,2	2.1	2.2	6.5	V
	VM	-	-	5.0	V
	VG	3	6.5	13	V
Pulse input frequency	fin	-	-	500	kHz

This product described in this specification is not judged whether it applies to COCOM regulations.
Please confirm in case of export.
This product is not designed for protection against radioactive rays.

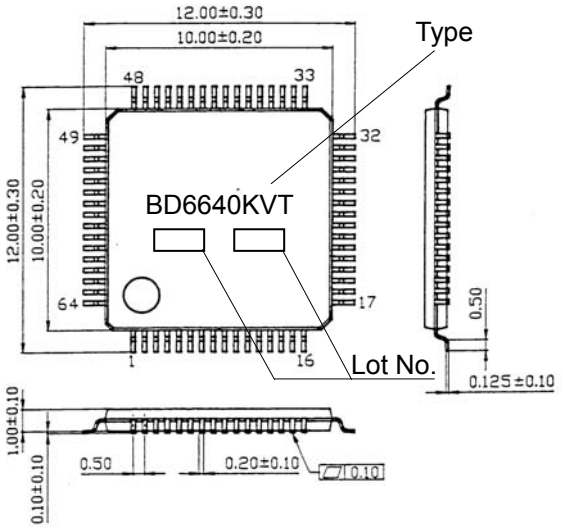
○Electrical characteristics

(Unless otherwise specified, Ta=25°C, VCC1, 2=2.2V, VM=1.0V, fin=176kHz)

Parameter	Symbol	Limit			Unit	Conditions
		Min.	Typ.	Max.		
Circuit current	ICC	-	4.4	7.0	mA	at operation in all blocks
	IST	-	1	10	μA	at standby in all blocks
Output ON resistance	RON	-	0.8	1.2	Ω	upper and lower ON resistance in total VG=10V
～Boost circuit～						
Output voltage	VG1	5.5	6.5	6.7	V	each input L
	VG2	4.4	5.2	—	V	at operation in all blocks
～Oscillation circuit～						
Self-propelled oscillating frequency	fOSC	50	100	160	kHz	
External clock synchronous range	fSYNC	—	—	500	kHz	input from EXTCLK pin
～Spindle (3-phase full-wave sensorless driver) block～						
Position detection comparator	VCO	-10	—	+10	mV	
Detection comparator input range	VCD	0	—	VCC-	V	
CST charge current	ICTO	-3.5	-2.1	-0.9	μA	CST=1V
CST discharge current	ICTI	1.0	3.6	7.5	mA	CST=1V
CSL charge current	ICLO	-3.5	-7.5	-13	μA	CSL=0.5V
CSL discharge current	ICLI	1.2	3.0	6.5	μA	CSL=0.5V
CSL clamp H voltage	VCLH	0.7	0.8	0.9	V	
Brake comparator input current	IBR	—	—	2.0	μA	BRK=VCC
Brake comparator input offset	VBO	-15	—	+15	mV	
Brake comparator input range	VBD	0	—	VCC-1	V	
FG output pull-up resistance	RBF	10	20	30	kΩ	
FG output L voltage	VOLF	—	0.2	0.3	V	Io=300μA
RIB offset voltage	VRO	10	18	30	mV	VM=0V RIB=500Ω
Pre-drive loop gain	VRP	500	650	850	mV	
M-phase check	VMCK	400	500	600	mV	
～Sled, focus, tracking, PWM power supply (stepping, H-bridge, and half-bridge driver) block～						
Logic H level input voltage	VINH	VCC-0.4	—	VCC	V	
Logic L level input voltage	VINL	0	—	0.4	V	
Logic H level input current	IINH1	—	—	1	μA	VIN=2.2V
	IINH2	—	350	600	μA	VIN=2.2V EXTCLK pin
Logic L level input current	IINL	-1	—	—	μA	VIN=0V
Output propagation delay time	TRISE	—	0.2	1	μsec	
	TFALL	—	0.1	0.7	μsec	
Short pulse response	tmin	120	—	—	nsec	input pulse width 200 ns

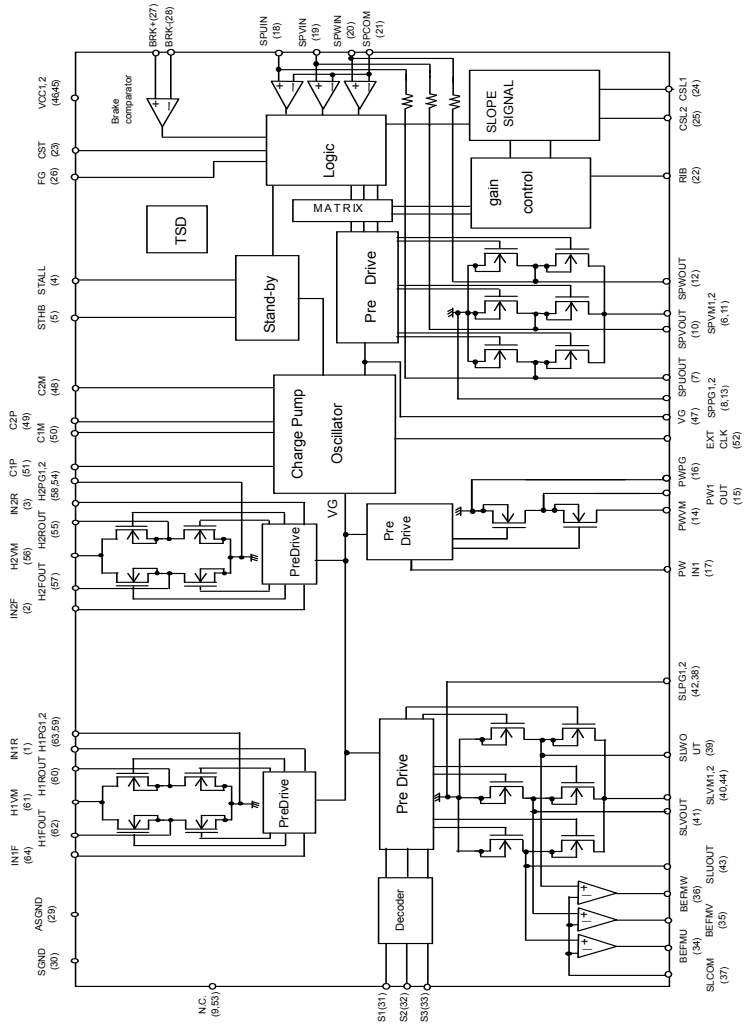
◎This product is not designed for protection against radioactive rays.

○Package outlines



TQFP64V outlines (Unit：mm)

○Block diagram



○Pin No./Pin name

NO.	Pin name	NO.	Pin name
1	IN1R	33	S3
2	IN2F	34	BEMFU
3	IN2R	35	BEMFV
4	STALL	36	BEMFW
5	STHB	37	SLCOM
6	SPVM1	38	SLPG2
7	SPUOUT	39	SLWOUT
8	SPPG1	40	SLVM2
9	N.C	41	SLVOUT
10	SPVOUT	42	SLPG1
11	SPVM2	43	SLUOUT
12	SPWOUT	44	SLVM1
13	SPPG2	45	VCC2
14	PWVM	46	VCC1
15	PWOUT	47	VG
16	PWPG	48	C2M
17	PWIN1	49	C2P
18	SPUIN	50	C1M
19	SPVIN	51	C1P
20	SPWIN	52	EXTCLK
21	SPCOM	53	N.C
22	RIB	54	H2PG2
23	CST	55	H2ROUT
24	CSL1	56	H2VM
25	CSL2	57	H2FOUT
26	FG	58	H2PG1
27	BRK+	59	H1PG2
28	BRK-	60	H1ROUT
29	ASGND	61	H1VM
30	SGND	62	H1FOUT
31	S1	63	H1PG1
32	S2	64	IN1F

○Notes on the use

(1) Absolute maximum ratings

If the input voltage or the operating temperature range exceeds absolute maximum ratings, IC may be damaged. No destruction mode (e.g., short-circuiting or open) can be specified in that case. If such special mode as will exceed absolute maximum ratings is assumed, take the physical safety measures, such as a fuse.

(2) Power supply lines

The regenerated current by BEMF of the motor will return. Therefore, take measures, such as the insertion of a capacitor between the power supply and GND as the pass of the regenerated current. Determine the capacitance in full consideration of all the characteristics of the electrolytic capacitor, because the electrolytic capacitor may loose some capacitance at low temperatures. If the connected power supply does not have sufficient current absorption capacity, regenerative current will cause the voltage of the power supply line to rise, which the product and its peripheral circuit may exceed the absolute maximum ratings. It is recommended to implement physical safety measures such as the insertion of a voltage clamp diode between the power supply and GND pins.

(3) Ground potential

Ensure a minimum GND pin potential in all operating conditions.

(4) Design for heat

Use the design for heat that allows for a sufficient margin in light of the power dissipation (Pd) in actual using conditions.

(5) Operation in strong magnetic field

Use caution when using the IC in the strong magnetic field as doing so may cause the IC to malfunction.

(6) ASO

When using the IC, make settings so that the output transistors for the motor will not be used under conditions in excess of the absolute maximum ratings and ASO.

(7) Thermal shutdown circuit

This IC incorporates thermal shutdown circuit(TSD circuit).

When the chip temperature becomes the one shown in below, TSD circuit operates and makes the coil output to motor open. It is designed to shut the IC off from runaway thermal operation. It is not designed to protect the IC or guarantee its operation. Do not continue to use the IC after operating this circuit or use the IC in an environment where the operation of this circuit is assumed.

TSD ON temperature[℃] (typ.)	Hysteresis temperature [℃] (typ.)
175	20

(8) Ground wiring pattern

When having both small signal and large current GND, it is recommended to isolate the two GND patterns, placing a single ground point at the application's reference point so that the pattern wiring resistance and voltage variations caused by large currents do not cause voltage variations of the small signal GND. Be careful not to change the GND wiring pattern of any external parts, either.

Notes

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